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Self-Protected Low Side Driver with Temperature and Current Limit

42 V, 14 A, Single N-Channel, SOT-223

NCV8403A/B is a three terminal protected Low-Side Smart Discrete device. The protection features include overcurrent, overtemperature, ESD and integrated Drain-to-Gate clamping for overvoltage protection. This device offers protection and is suitable for harsh automotive environments.

Features

- Short Circuit Protection
- Thermal Shutdown with Automatic Restart
- Over Voltage Protection
- Integrated Clamp for Inductive Switching
- ESD Protection
- dV/dt Robustness
- Analog Drive Capability (Logic Level Input)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

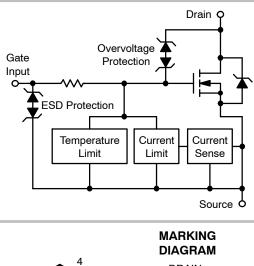
- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial

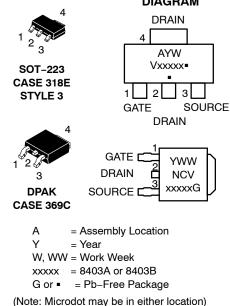


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V _{DSS} (Clamped)	R _{DS(on)} TYP	I _D MAX (Limited)
42 V	53 mΩ @ 10 V	15 A





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage Internally Clamped	V _{DSS}	42	Vdc
Gate-to-Source Voltage	V _{GS}	±14	Vdc
Drain Current Continuous	I _D	Internally Lim	
Total Power Dissipation - SOT-223 Version(@ $T_A = 25^{\circ}C$ (Note 1)(@ $T_A = 25^{\circ}C$ (Note 2)Total Power Dissipation - DPAK Version(@ $T_A = 25^{\circ}C$ (Note 1)(@ $T_A = 25^{\circ}C$ (Note 2)	PD	1.13 1.56 1.32 2.5	W
Thermal Resistance – SOT-223 Version Junction-to-Soldering Point Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2) Thermal Resistance – DPAK Version Junction-to-Soldering Point Junction-to-Ambient (Note 1) Junction-to-Ambient (Note 2)	$\begin{array}{c} R_{\theta JS} \\ R_{\theta JA} \\ R_{\theta JA} \\ R_{\theta JS} \\ R_{\theta JA} \\ R_{\theta JA} \\ R_{\theta JA} \end{array}$	12 110 80 2.5 95 50	°C/W
Single Pulse Inductive Load Switching Energy (V_{DD} = 25 Vdc, V_{GS} = 5.0 V, I_L = 2.8 A, L = 120 mH, R_G = 25 Ω)	E _{AS}	470	mJ
Load Dump Voltage (V_{GS} = 0 and 10 V, R_I = 2.0 $\Omega,$ R_L = 4.5 $\Omega,$ t_d = 400 ms)	V _{LD}	55	V
Operating Junction Temperature	TJ	-40 to 150	°C
Storage Temperature	T _{stg}	-55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Surface mounted onto minimum pad size (0.412" square) FR4 PCB, 1 oz cu.
Mounted onto 1" square pad size (1.127" square) FR4 PCB, 1 oz cu.

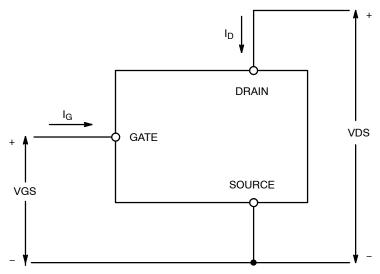


Figure 1. Voltage and Current Convention

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					_	
$ \begin{array}{l} \mbox{Drain-to-Source Clamped Breakdown Vol} \\ (V_{GS}=0~Vdc,~I_D=250~\mu Adc) \\ (V_{GS}=0~Vdc,~I_D=250~\mu Adc,~T_J=-400) \end{array} $	5	V _{(BR)DSS}	42 40	46 45	51 51	Vdc Vdc
Zero Gate Voltage Drain Current $(V_{DS} = 32 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$ $(V_{DS} = 32 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, T_J = 150^{\circ}\text{C})$ (Note 3)		I _{DSS}		0.6 2.5	5.0 -	μAdc
Gate Input Current ($V_{GS} = 5.0 \text{ Vdc}, V_{DS} = 0 \text{ Vdc}$)		I _{GSS}	-	50	125	μAdc
ON CHARACTERISTICS						
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 1.2 mAdc) Threshold Temperature Coefficient (Negative)		V _{GS(th)}	1.0 -	1.7 5.0	2.2 -	Vdc mV/°C
$ Static Drain-to-Source On-Resistance (Note 4) \\ (V_{GS} = 10 \ Vdc, \ I_D = 3.0 \ Adc, \ T_J @ 25^{\circ}C) \\ (V_{GS} = 10 \ Vdc, \ I_D = 3.0 \ Adc, \ T_J @ 150^{\circ}C) \ (Note 3) $		R _{DS(on)}	-	53 95	68 123	mΩ
Static Drain-to-Source On-Resistance (Note 4) (V _{GS} = 5.0 Vdc, I _D = 3.0 Adc, T _J @ 25°C) (V _{GS} = 5.0 Vdc, I _D = 3.0 Adc, T _J @ 150°C) (Note 3)		R _{DS(on)}		63 105	76 135	mΩ
Source–Drain Forward On Voltage $(I_S = 7.0 \text{ A}, V_{GS} = 0 \text{ V})$		V _{SD}	-	0.95	1.1	V
SWITCHING CHARACTERISTICS (Note 3	3)	-	-	-	-	-
Turn–ON Time (10% V_{IN} to 90% $I_{\text{D}})$	V _{IN} = 0 V to 5 V, V _{DD} = 25 V	ton		44		μs
Turn–OFF Time (90% V_{IN} to 10% $I_{\text{D}})$	$I_D = 1.0 \text{ A}, \text{ Ext } R_G = 2.5 \Omega$	t _{OFF}		84		
Turn–ON Time (10% V_{IN} to 90% $I_{\text{D}})$	V _{IN} = 0 V to 10 V, V _{DD} = 25 V	t _{ON}		15		
Turn–OFF Time (90% V_{IN} to 10% $I_{\text{D}})$	$I_{\rm D} = 1.0 \text{ A}, \text{ Ext } R_{\rm G} = 2.5 \Omega$	t _{OFF}		116		
Slew-Rate ON (20% V_{DS} to 50% $V_{DS})$	V_{in} = 0 to 10 V, V_{DD} = 12 V, R_L = 4.7 Ω	$-dV_{DS}/dt_{ON}$		2.43		V/µs
Slew-Rate OFF (80% V_{DS} to 50% $V_{DS})$	$R_L = 4.7 \ \Omega$	dV_{DS}/dt_{OFF}		0.83		
SELF PROTECTION CHARACTERISTICS	$(T_J = 25^{\circ}C \text{ unless otherwise noted})$ (N	lote 5)				
Current Limit	V _{GS} = 5.0 V, V _{DS} = 10 V V _{GS} = 5.0 V, T _J = 150°C (Note 3)	I _{LIM}	10 5.0	15 10	20 15	Adc
Current Limit	V_{GS} = 10 V, V_{DS} = 10 V V_{GS} = 10 V, T_{J} = 150°C (Note 3)	I _{LIM}	12 8.0	17 13	22 18	Adc
Temperature Limit (Turn-off)	V _{GS} = 5.0 Vdc (Note 3)	T _{LIM(off)}	150	175	200	°C
Thermal Hysteresis	$V_{GS} = 5.0 \text{ Vdc}$	$\Delta T_{LIM(on)}$	-	15	-	°C
Temperature Limit (Turn-off)	V _{GS} = 10 Vdc (Note 3)	T _{LIM(off)}	150	165	185	°C
Thermal Hysteresis	V _{GS} = 10 Vdc	$\Delta T_{LIM(on)}$	-	15	-	°C
GATE INPUT CHARACTERISTICS (Note	/		-			
Device ON Gate Input Current	V _{GS} = 5 V I _D = 1.0 A	I _{GON}		50		μA
	V _{GS} = 10 V I _D = 1.0 A			400		
Current Limit Gate Input Current	V_{GS} = 5 V, V_{DS} = 10 V	I _{GCL}		0.1		mA
	V _{GS} = 10 V, V _{DS} = 10 V			0.6		
Thermal Limit Fault Gate Input Current	V_{GS} = 5 V, V_{DS} = 10 V	I _{GTL}		0.45		mA
	V_{GS} = 10 V, V_{DS} = 10 V			1.5		
ESD ELECTRICAL CHARACTERISTICS		ote 3)	1		1	1
Electro-Static Discharge Capability	Human Body Model (HBM)	ESD	4000	-	-	V
Electro-Static Discharge Capability	Machine Model (MM)	ESD	400	-	-	V

Not subject to production testing.
Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2%.
Fault conditions are viewed as beyond the normal operating range of the part.

TYPICAL PERFORMANCE CURVES

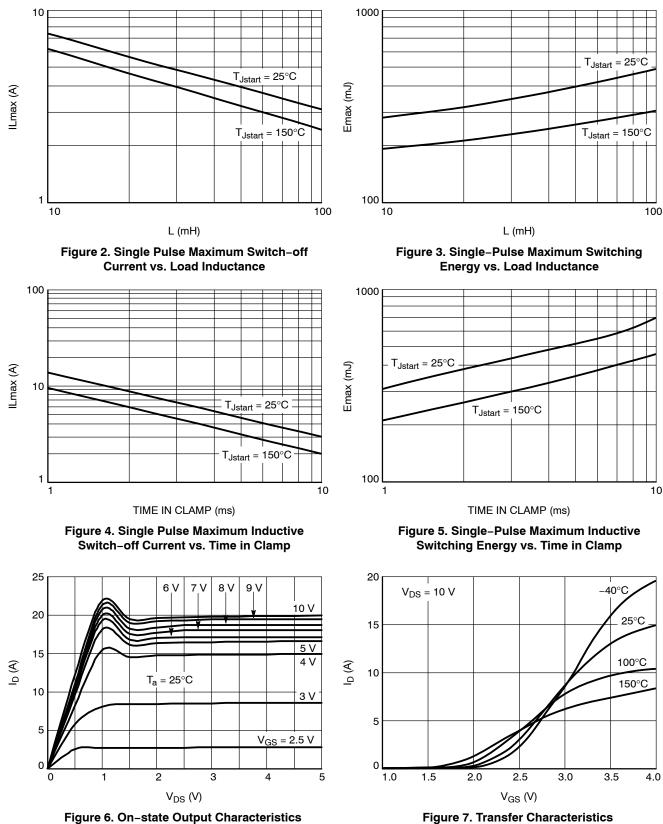
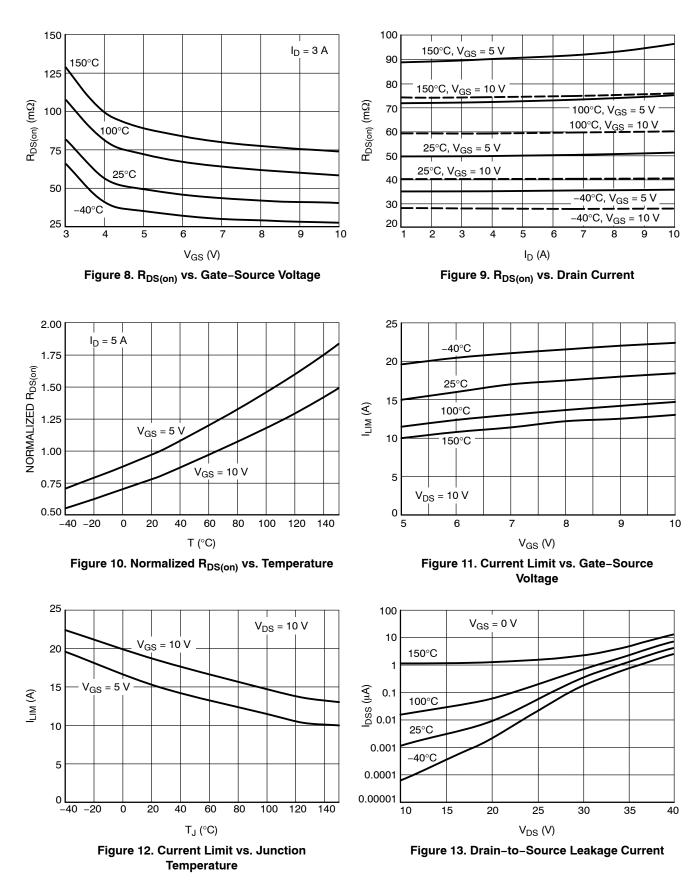
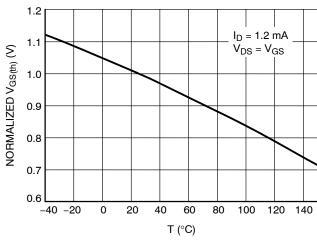


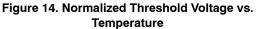
Figure 7. Transfer Characteristics

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES





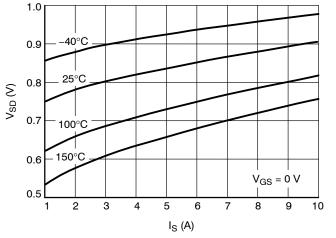
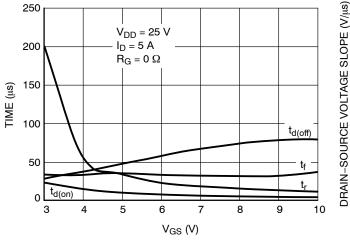
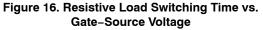
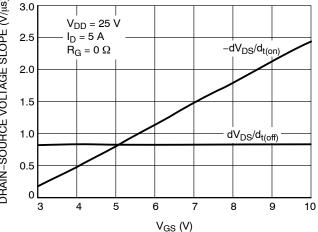


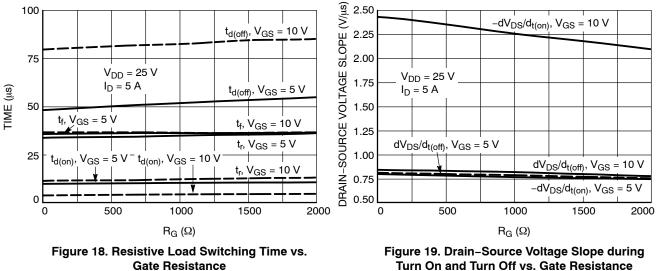
Figure 15. Source-Drain Diode Forward Characteristics





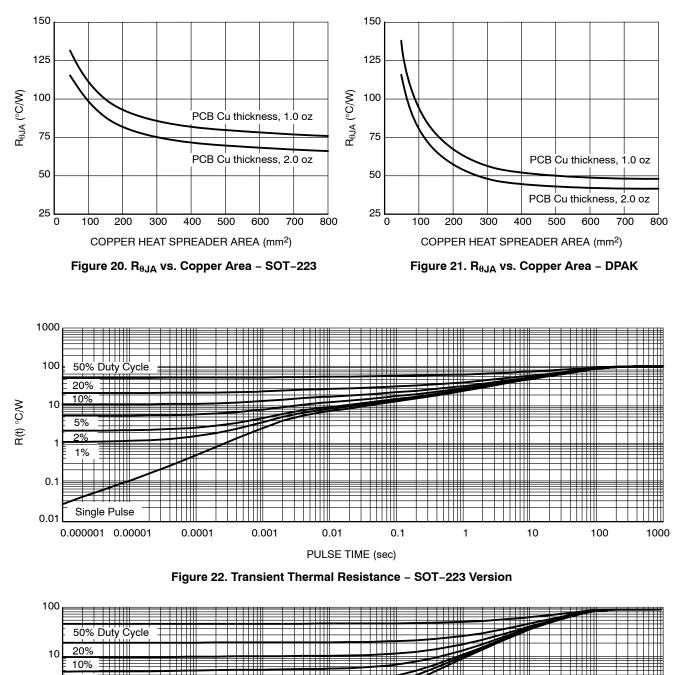






Turn On and Turn Off vs. Gate Resistance

TYPICAL PERFORMANCE CURVES



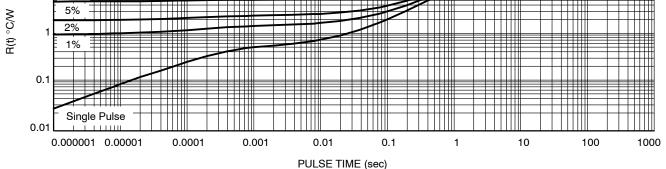


Figure 23. Transient Thermal Resistance – DPAK Version

TEST CIRCUITS AND WAVEFORMS

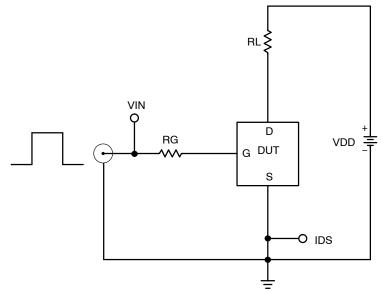


Figure 24. Resistive Load Switching Test Circuit

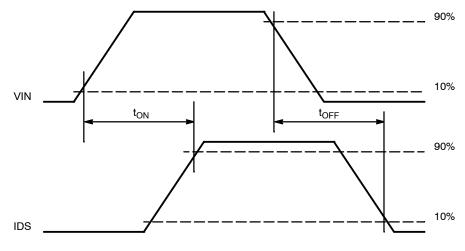


Figure 25. Resistive Load Switching Waveforms

TEST CIRCUITS AND WAVEFORMS

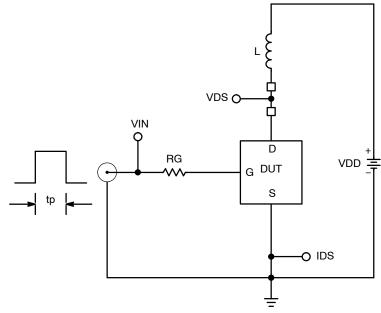


Figure 26. Inductive Load Switching Test Circuit

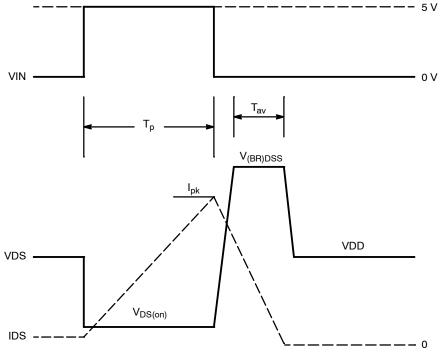


Figure 27. Inductive Load Switching Waveforms

ORDERING INFORMATION

Device	Package	Shipping [†]	
NCV8403ASTT1G	SOT-223 (Pb-Free)	1000 / Tape & Reel	
NCV8403ASTT3G	SOT-223 (Pb-Free)	4000 / Tape & Reel	
NCV8403ADTRKG	DPAK (Pb-Free)	2500 / Tape & Reel	
NCV8403BDTRKG	DPAK (Pb-Free)	2500 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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